

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
1	BRS	L1	2139	(solder adj lead) or (lead adj free adj solder)	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 19:30	
2	BRS	L2	678	1 and tin	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 19:30	
3	BRS	L3	47	2 and (alloy adj composition)	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 19:46	
4	BRS	L4	0	3 and (mass same phospho\$3)	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 19:32	
5	BRS	L5	7	3 and phospho\$3	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 19:46	
6	BRS	L7	32	420/\$.ccls. and (solder adj lead)	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 19:42	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
7	BRS	L9	0	8 and plating	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 19:42	
8	BRS	L8	2	6 and (copper adj strip)	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 19:43	
9	BRS	L6	63	420/\$.ccls. and (lead adj free adj solder)	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 20:31	
10	BRS	L10	10	6 and plating	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 19:48	
11	BRS	L12	0	11 and phospho\$3	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 19:48	
12	BRS	L11	4	10 and (alloy adj composition)	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 19:48	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
13	BRS	L13	40	148/\$.ccls. and (lead adj free adj solder)	USPAT; EPO; JPO; DERWENT; USOCR	2002/05/03 19:48	
14	BRS	L14	19	13 and (alloy adj composition)	USPAT; EPO; JPO; DERWENT; USOCR	2002/05/03 19:48	
15	BRS	L16	0	15 and plating	USPAT; EPO; JPO; DERWENT; USOCR	2002/05/03 19:48	
16	BRS	L15	5	14 and phospho\$3	USPAT; EPO; JPO; DERWENT; USOCR	2002/05/03 20:28	
17	BRS	L17	8353	connecting adj lead	USPAT; EPO; JPO; DERWENT; USOCR	2002/05/03 20:30	
18	BRS	L18	2097	17 and (copper or strip)	USPAT; EPO; JPO; DERWENT; USOCR	2002/05/03 20:31	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
19	BRS	L19	325	18 and plating	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 20:31	
20	BRS	L20	0	19 and (lead adj free adj solder)	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 20:46	
21	BRS	L21	0	18 and (lead adj free adj solder)	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 20:33	
22	BRS	L22	556	18 and solder	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 20:33	
23	BRS	L23	125	22 and tin	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 20:34	
24	BRS	L24	10	23 and phosphorus	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 20:48	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
25	BRS	L25	483	lead adj free adj solder	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 20:47	
26	BRS	L26	64	25 and plating	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 20:48	
27	BRS	L27	2	26 and phosphorus	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 20:48	
28	BRS	L29	0	27 and strip	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 20:48	
29	BRS	L28	2	27 and copper	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 20:52	
30	BRS	L31	1277	174/260.ccls.	USPA T; EPO; JPO; DERW ENT; USOC R	2002/05/0 3 20:53	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
31	BRS	L32	7700	solder\$3 adj paste	USPAT; EPO; JPO; DERWENT; USOCR	2002/05/03 20:53	
32	BRS	L34	54	30 and 32	USPAT; EPO; JPO; DERWENT; USOCR	2002/05/03 20:54	
33	BRS	L36	111	31 and 32	USPAT; EPO; JPO; DERWENT; USOCR	2002/05/03 20:56	
34	BRS	L37	1	36 and phosphorus	USPAT; EPO; JPO; DERWENT; USOCR	2002/05/03 20:56	
35	BRS	L38	10	("4603805" "5166774" "5591941" "5699611" "5720100" "5808874" "5844315" "5910644" "6025649" "6127735") .PN.	USPAT	2002/05/03 20:59	
36	BRS	L33	2	30 and 25	USPAT; EPO; JPO; DERWENT; USOCR	2002/05/03 21:03	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
37	BRS	L35	3	31 and 25	USPAT; EPO; JPO; DERWENT; USOCR	2002/05/03 21:06	
38	BRS	L39	11	("5541828" "5588848" "5724016" "5750935" "5764485" "5787569" "5835350" "5872400" "5926373" "6002172" "6137164") .PN.	USPAT	2002/05/03 21:07	
39	BRS	L30	433	174/263.ccls.	USPAT; EPO; JPO; DERWENT; USOCR	2002/05/03 21:10	